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FDN86246 N-Channel PowerTrench[®] MOSFET 150 V, 1.6 A, 261 m Ω

Features

- Max r_{DS(on)} = 261 mΩ at V_{GS} = 10 V, I_D = 1.6 A
- Max $r_{DS(on)}$ = 359 m Ω at V_{GS} = 6 V, I_D = 1.4 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL tested
- RoHS Compliant

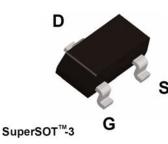


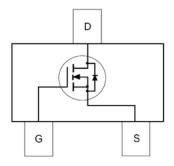
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Application

PD Switch





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DS}	Drain to Source Voltage		150	V
V _{GS}	Gate to Source Voltage		±20	V
1	-Continuous	(Note 1a)	1.6	٨
D	-Pulsed		6	— A
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	13	mJ
D	Power Dissipation	(Note 1a)	1.5	w
P _D	Power Dissipation	(Note 1b)	0.6	vv
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	75	°C/M
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	80	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
246	FDN86246	SSOT-3	7 "	8 mm	3000 units

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December 2010

ΔT _J DSS GSS	Breakdown Voltage Temperature	I_{D} = 250 μ A, V_{GS} = 0 V	150			V
oss oss	Coefficient	I_D = 250 μ A, referenced to 25 °C		106		mV/°C
SS	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μA
	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
n Characi	teristics (Note 2)	00 00				
	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2	3.4	4	V
	Gate to Source Threshold Voltage		_	-		
<u>00(ui</u>)	Temperature Coefficient	I_{D} = 250 $\mu A,$ referenced to 25 °C		-9		mV/°0
		V _{GS} = 10 V, I _D = 1.6 A		195	261	
DS(on)	Static Drain to Source On Resistance	V _{GS} = 6 V, I _D = 1.4 A		242	359	mΩ
		V_{GS} = 10 V, I _D = 1.6 A, T _J = 125 °C		359	481	
FS	Forward Transconductance	V _{DS} = 10 V, I _D = 1.6 A		4		S
vnamic C	haracteristics					
-	Input Capacitance			168	225	pF
	Output Capacitance	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		21	30	pF
	Reverse Transfer Capacitance			1.6	5	pF
	Gate Resistance			0.9		Ω
•	Characteristics					
-	Characteristics			4 5	10	
	Turn-On Delay Time			4.5	10	ns
	Rise Time	V _{DD} = 75 V, I _D = 1.6 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		1.1	10	ns
	Turn-Off Delay Time	$v_{GS} = 10 v, R_{GEN} = 0.02$		8	16	ns
	Fall Time			2.9	10	ns
9	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		2.9	5	nC
9	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 75 V,$ $I_{D} = 1.6 A$		1.6	3	nC
90	Gate to Source Gate Charge	I _D = 1.6 A		0.9		nC
) _{gd}	Gate to Drain "Miller" Charge			0.8		nC
rain-Sour	ce Diode Characteristics					
SD	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = 1.6 A (Note 2)		0.83	1.3	V
	Reverse Recovery Time	I _E = 1.6 A, di/dt = 100 A/μs		44	70	ns
۵ _{rr}	Reverse Recovery Charge	$I_{\rm F} = 1.0$ A, di/dt = 100 A/µs		29	47	nC

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Symbol Parameter

Electrical Characteristics T_J = 25 °C unless otherwise noted

Off Characteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		106		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20 V, V _{DS} = 0 V			±100	nA

Test Conditions

Min

Тур

Max

Units

On

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$	2	3.4	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		-9		mV/°C
		V _{GS} = 10 V, I _D = 1.6 A		195	261	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 6 V, I _D = 1.4 A		242	359	mΩ
		V_{GS} = 10 V, I _D = 1.6 A, T _J = 125 °C		359	481	
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 1.6 A		4		S
	- Chave stavistics					

Dyn

C _{iss}	Input Capacitance		168	225	pF
C _{oss}	Output Capacitance	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz	21	30	pF
C _{rss}	Reverse Transfer Capacitance		1.6	5	pF
R _g	Gate Resistance		0.9		Ω

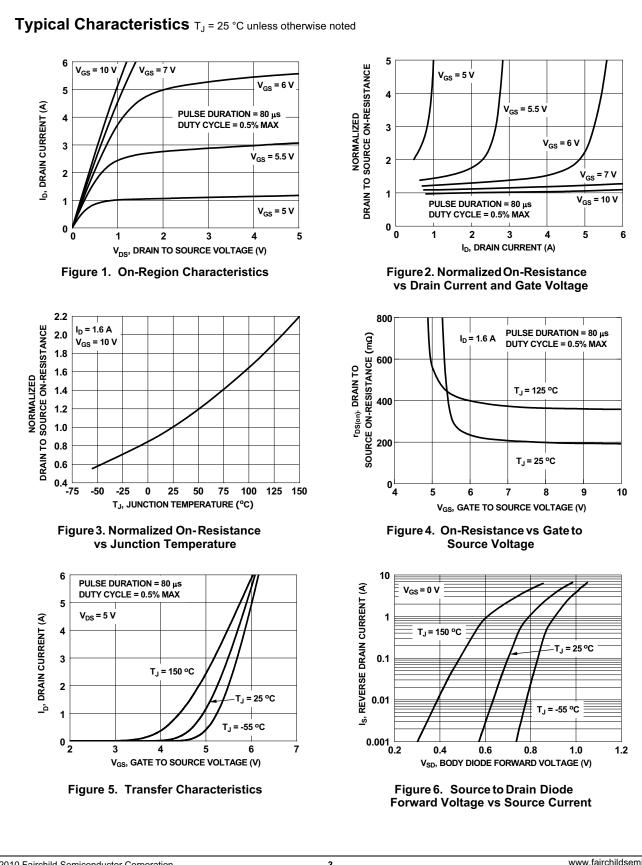
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t _{d(on)}	Turn-On Delay Time		4.5	10	ns
t _r	Rise Time	V _{DD} = 75 V, I _D = 1.6 A,	1.1	10	ns
t _{d(off)}	Turn-Off Delay Time	V_{DD} = 75 V, I _D = 1.6 A, V _{GS} = 10 V, R _{GEN} = 6 Ω	8	16	ns
t _f	Fall Time		2.9	10	ns
Q _g	Total Gate Charge	V _{GS} = 0 V to 10 V	2.9	5	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 75 V,$	1.6	3	nC
Q _{gs}	Gate to Source Gate Charge	I _D = 1.6 A	0.9		nC
Q _{gd}	Gate to Drain "Miller" Charge		0.8		nC

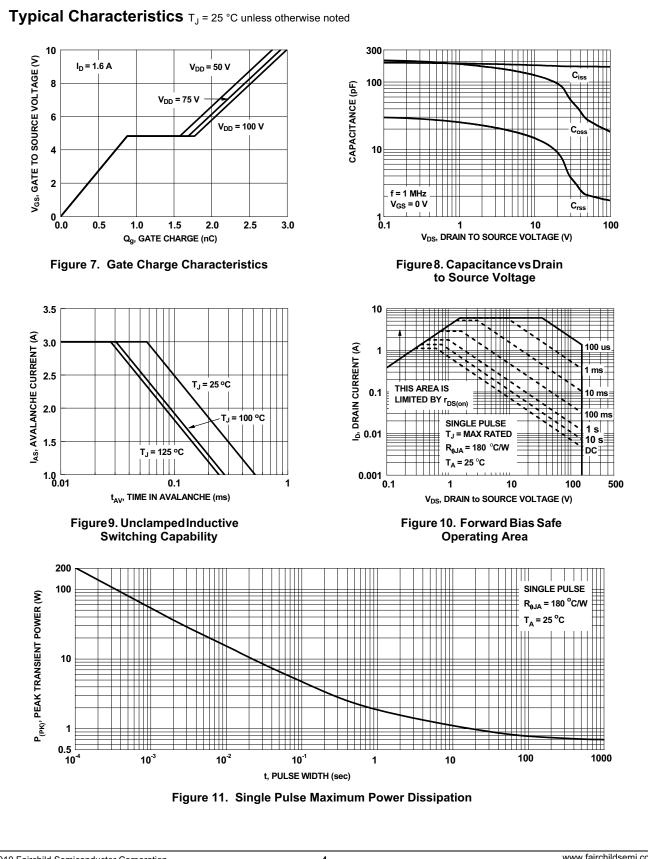
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V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 1.6 A$ (Note 2)	0.83	1.3	V
t _{rr}	Reverse Recovery Time	I _F = 1.6 A, di/dt = 100 A/μs		ns	
Q _{rr}	Reverse Recovery Charge	I _F = 1.6 A, αι/αt = 100 A/μs 29 47		nC	

3. Starting T_J = 25 °C; N-ch: L = 3 mH, I_{AS} = 3 A, V_{DD} = 150 V, V_{GS} = 10 V.



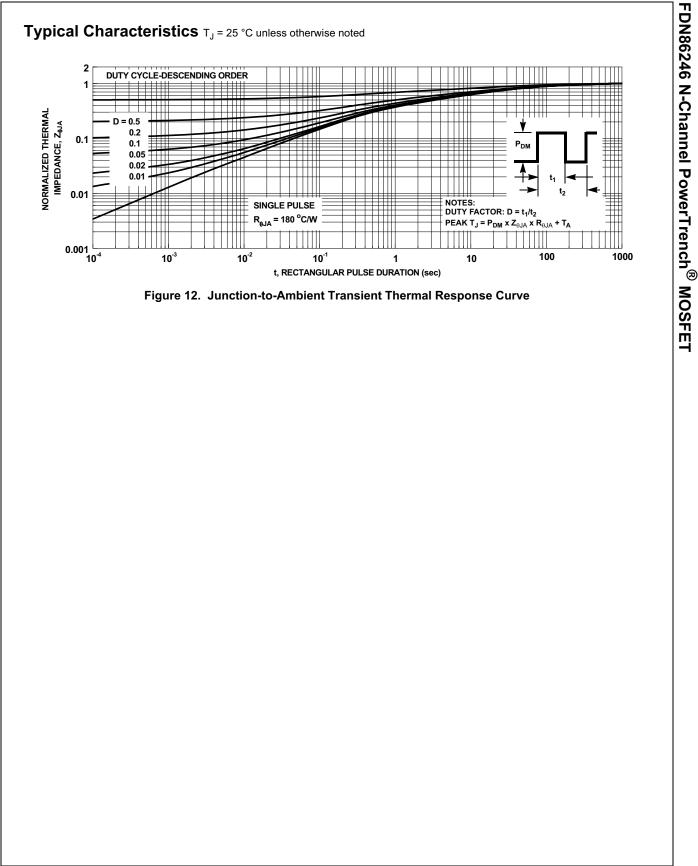
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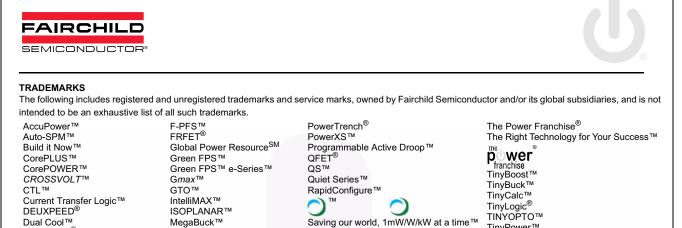


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FDN86246 N-Channel PowerTrench[®] MOSFET





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SuperSOT™-3

SuperSOT™-6

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